

ON Semiconductor®

FCPF380N60-F152

N-Channel SuperFET[®] II MOSFET Description 600 V, 10.2 A, 380 m Ω

Features

- 650 V @T_{.1} = 150°C
- Max. R_{DS(on)} = 380 mΩ
- Ultra low gate charge (typ. Q_g = 30 nC)
- Low effective output capacitance (typ. Coss.eff = 95 pF)
- 100% avalanche tested

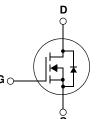
Aplications

- LCD / LED / PDP TV Lighting
- · Solar Inverter
- AC-DC Power Supply



SuperFET[®]II MOSFET is ON Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This advanced technology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and

higher avalanche energy. Consequently, SuperFET[®]II MOSFET is suitable for various AC/DC power conversion for system miniaturization and higher efficiency.



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol		Parameter		FCPF380N60-F152	Unit	
V _{DSS}	Drain to Source Voltage			600	V	
V	Cata ta Cauraa Valtaga	-DC	-DC		v	
V _{GSS}	Gate to Source Voltage	-AC	(f>1HZ)	±30	v	
1	Drain Current	-Continuous ($T_c = 25^{\circ}C$)		10.2*	Α	
ID	Drain Current	-Continuous ($T_c = 100^{\circ}C$)		6.4*	- A	
I _{DM}	Drain Current	- Pulsed	(Note 1)	30.6*	А	
E _{AS}	Single Pulsed Avalanche Ene	ergy	(Note 2)	211.6	mJ	
I _{AR}	Avalanche Current		(Note 1)	2.3	А	
E _{AR}	Repetitive Avalanche Energy	,	(Note 1)	1.06	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		(Note 3)	20	V/ns	
uv/ut	MOSFET dv/dt			100	- v/115	
D	Deven Dississation	(T _C = 25°C)		31	W	
P _D	Power Dissipation	- Derate above 25°C		0.25	W/ºC	
T _J , T _{STG}	Operating and Storage Temp	erature Range		-55 to +150	°C	
Τ _L	Maximum Lead Temperature 1/8" from Case for 5 Second	e		300	°C	

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCPF380N60-F152	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	4	
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	°C/W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	62.5	

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Package Marking and Ordering Information

Device Marking	Device	Package	Eco Status	Packaging Type	Quantity
FCPF380N60	FCPF380N60-F152	TO-220F	Green 🧭	Tube	50

Electrical Characteristics $T_{C} = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
D\/	Drain to Source Breakdown Voltage	$V_{GS} = 0V, I_{D} = 10mA, T_{J} = 25^{\circ}C$	600	-	-	V
BV _{DSS}	Drain to Source Breakdown voltage	$V_{GS} = 0V, I_{D} = 10mA, T_{J} = 150^{\circ}C$	650	-	-	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 10$ mA, Referenced to 25°C	-	0.6	-	V/ºC
BV _{DS}	Drain-Source Avalanche Breakdown Voltage	$V_{GS} = 0V, I_D = 10A$	-	700	-	V
1	Zero Gate Voltage Drain Current	$V_{DS} = 480V, V_{GS} = 0V$	-	-	10	
DSS		$V_{DS} = 480V, T_{C} = 125^{\circ}C$	-	-	10	- μΑ
I _{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2.5	-	3.5	V
R _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10V, I_{D} = 5A$	-	0.33	0.38	Ω
9 FS	Forward Transconductance	$V_{DS} = 20V, I_{D} = 5A$	-	11	-	S

Dynamic Characteristics

Ciss	Input Capacitance		-	1250	1665	pF
C _{oss}	Output Capacitance	− V _{DS} = 25V, V _{GS} = 0V _ f = 1MHz	-	905	1205	pF
C _{rss}	Reverse Transfer Capacitance		-	45	60	pF
C _{oss}	Output Capacitance	V _{DS} = 380V, V _{GS} = 0V, f = 1MHz	-	23	-	pF
C _{oss} eff.	Effective Output Capacitance	$V_{DS} = 0V$ to 480V, $V_{GS} = 0V$	-	95	-	pF
Q _{g(tot)}	Total Gate Charge at 10V	V _{DS} = 380V, I _D = 5A	-	30	40	nC
Q _{gs}	Gate to Source Gate Charge	$V_{GS} = 10V$	-	5	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	(Note 4)	-	10	-	nC
ESR	Equivalent Series Resistance	f = 1MHz	-	1	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	14	38	ns
t _r		$V_{DD} = 380V, I_D = 5A$	-	7	24	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10V, R = 4.7Ω	-	45	100	ns
t _f	Turn-Off Fall Time	(Note 4)	-	6	22	ns

Drain-Source Diode Characteristics

I _S	Maximum Continuous Drain to Source Dioc	Maximum Continuous Drain to Source Diode Forward Current			10.2	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current			-	30.6	Α
V_{SD}	Drain to Source Diode Forward Voltage $V_{GS} = 0V$, $I_{SD} = 5A$		-	-	1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0V, I_{SD} = 5A$	-	240	-	ns
Q _{rr}	Reverse Recovery Charge	$dI_F/dt = 100A/\mu s$	-	2.7	-	μC

Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. I_{AS} = 2.3A, V_{DD} = 50V, R_{G} = 25 Ω , Starting T_{J} = 25 $^{\circ}C$

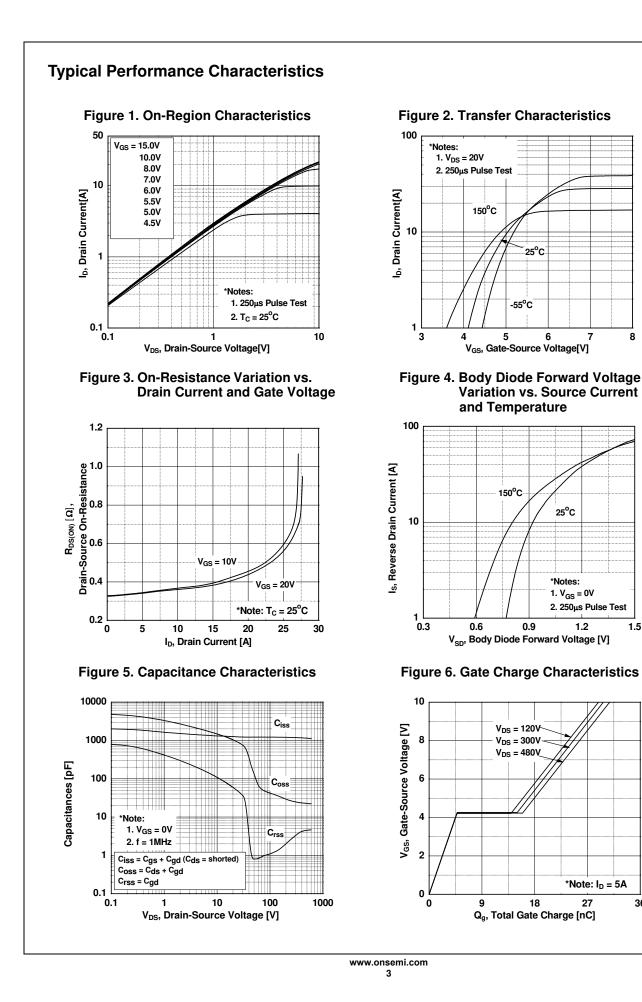
3. $I_{SD} \leq$ 5.1A, di/dt \leq 200A/µs, $V_{DD} \leq BV_{DSS},$ Starting T_J = 25°C

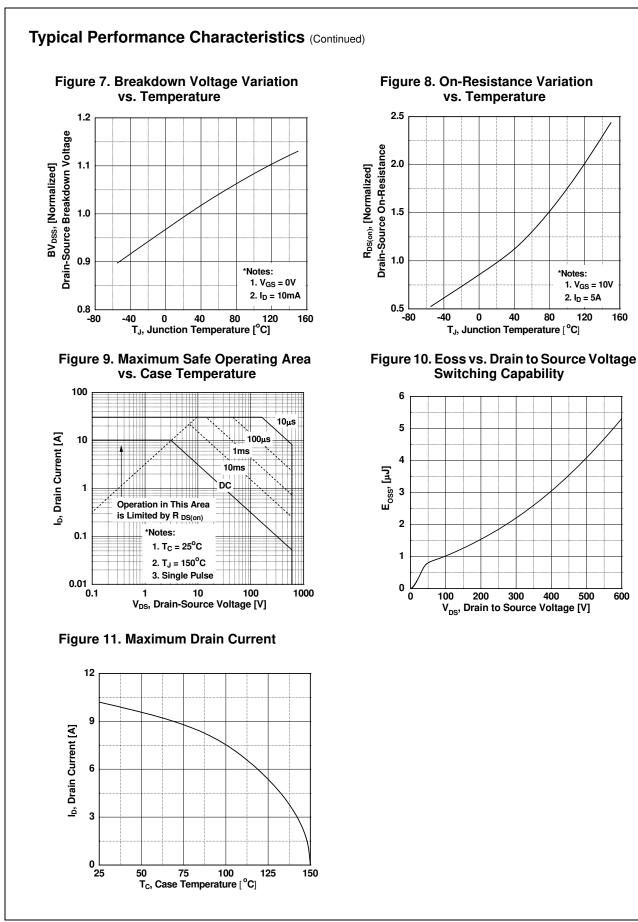
4. Essentially Independent of Operating Temperature Typical Characteristics

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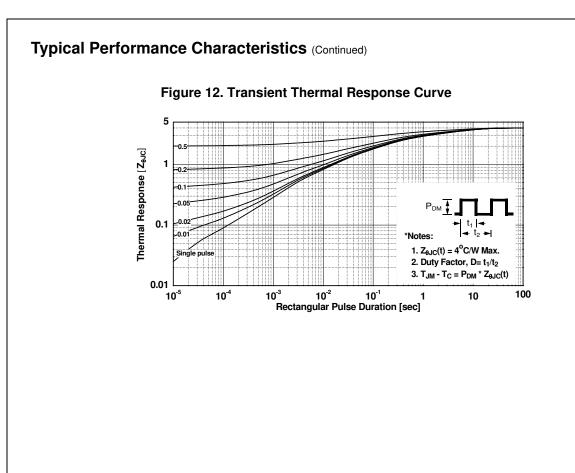
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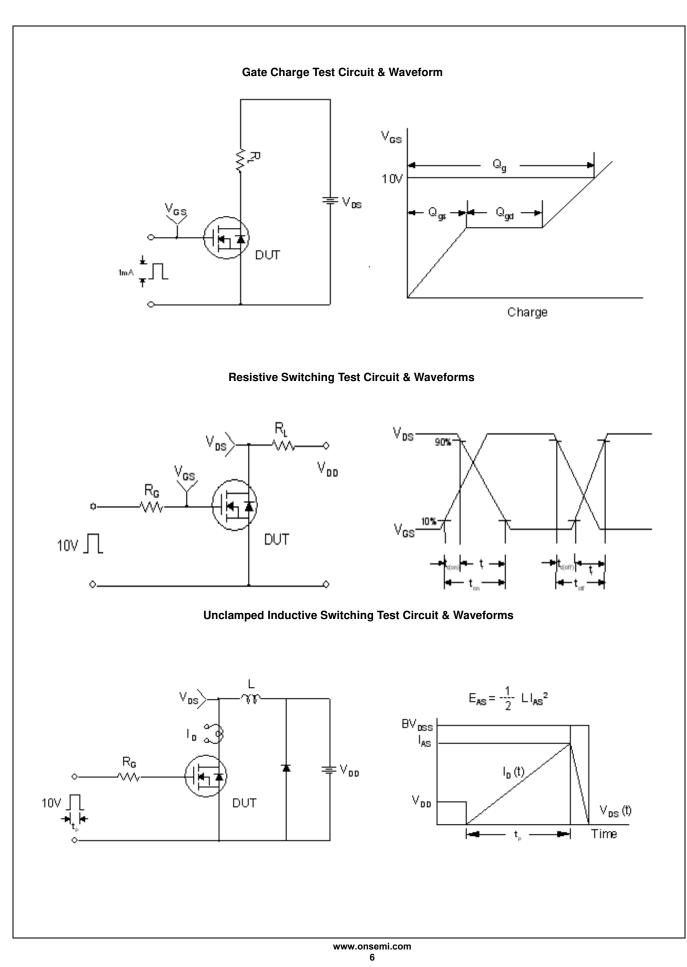




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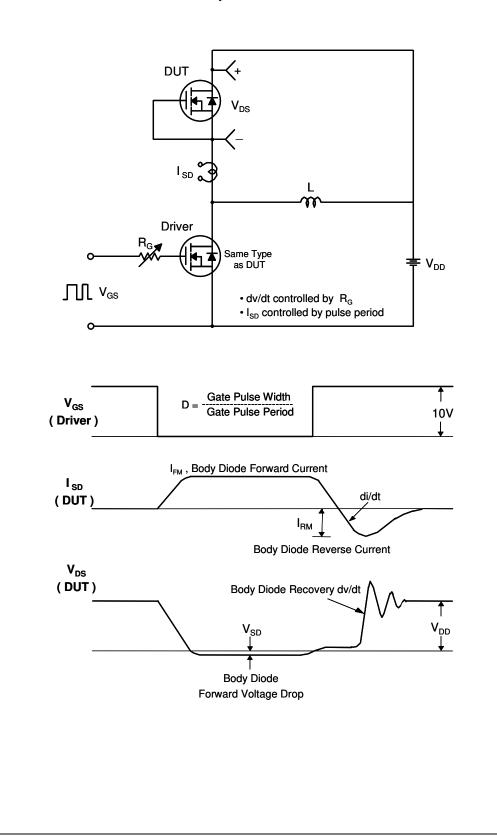


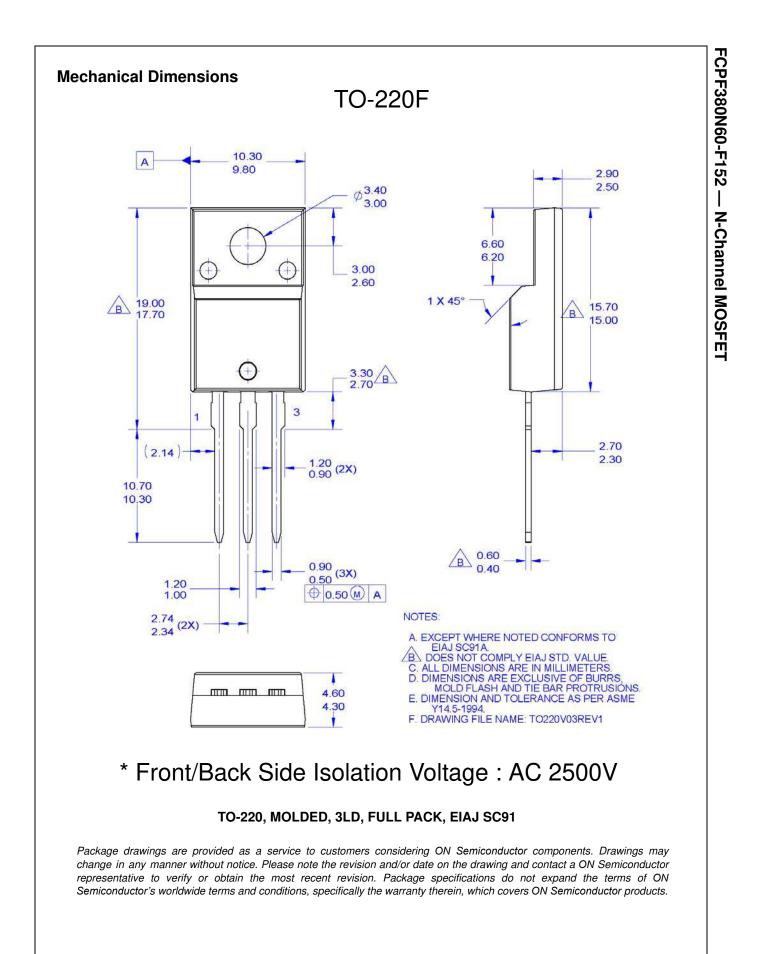
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Peak Diode Recovery dv/dt Test Circuit & Waveforms





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